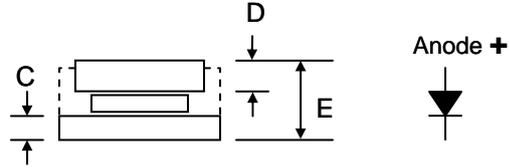


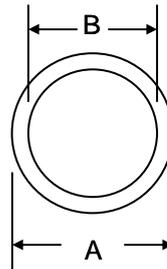
Features

- Diffused Junction
- Low Leakage
- Low Cost
- High Surge Current Capability
- Die Size 164 mil HEX



Mechanical Data

- Case: Cell Diode Passivated with Silicon Rubber
- Terminal: Copper Disc with Ag Plated
- Polarity: Indicated by Large Disc On Cathode Side, Add "R" Suffix to Indicate Reverse Polarity, i.e. C25AR
- Mounting Position: Any
- **Lead Free: For RoHS / Lead Free Version, Add "-LF" Suffix to Part Number, See Page 2**



C25		
Dim	Min	Max
A	—	5.70
B	—	4.82
C	0.75	—
D	1.0	—
E	—	2.2
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	C25A	C25B	C25D	C25G	C25J	C25K	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	V
Average Rectified Output Current @ $T_C = 150^\circ\text{C}$	I_O	25						A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	400						A
Forward Voltage @ $I_F = 50\text{A}$	V_{FM}	1.08						V
Peak Reverse Current At Rated DC Blocking Voltage @ $T_A = 25^\circ\text{C}$	I_{RM}	3.0						μA

Typical Thermal Resistance Junction to Ambient R